

# isc N-Channel MOSFET Transistor

# SPU03N60C3

**• FEATURES**

- With TO-251(IPAK) packaging
- High speed switching
- Easy to use
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

**• APPLICATIONS**

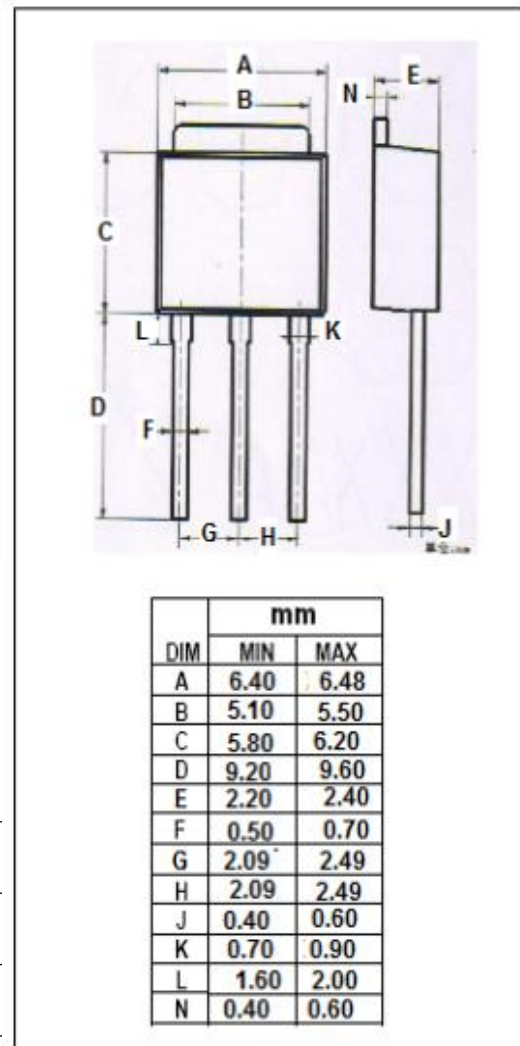
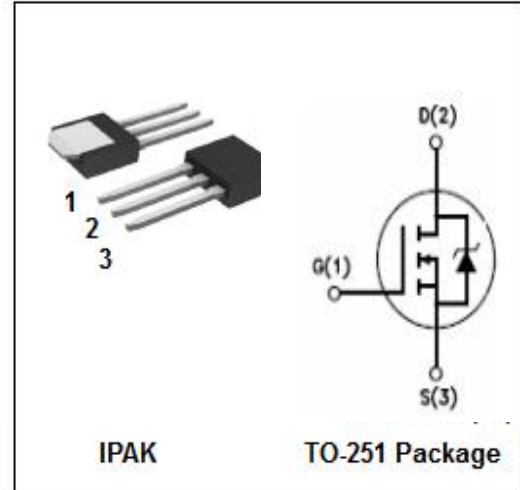
- Power supply
- DC-DC converters
- Motor control
- Switching applications

**• ABSOLUTE MAXIMUM RATINGS(T<sub>a</sub>=25°C)**

SYMBOL	PARAMETER	VALUE	UNIT
V <sub>DSS</sub>	Drain-Source Voltage	600	V
V <sub>GSS</sub>	Gate-Source Voltage	±30	V
I <sub>D</sub>	Drain Current-Continuous	3.2	A
I <sub>DM</sub>	Drain Current-Single Pulsed	9.6	A
P <sub>D</sub>	Total Dissipation	38	W
T <sub>j</sub>	Operating Junction Temperature	-55~150	°C
T <sub>stg</sub>	Storage Temperature	-55~150	°C

**• THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	MAX	UNIT
Rth(ch-c)	Channel-to-case thermal resistance	3.3	°C/W
Rth(ch-a)	Channel-to-ambient thermal resistance	75	°C/W



**isc N-Channel MOSFET Transistor****SPU03N60C3****ELECTRICAL CHARACTERISTICS** $T_C=25^{\circ}\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V; I_D=0.25mA$	600			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}; I_D=0.135mA$	2.1		3.9	V
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS}=10V; I_D=2A$		1.26	1.4	$\Omega$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V; V_{DS}=0V$			$\pm 0.1$	$\mu A$
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=600V; V_{GS}=0V; T_J=25^{\circ}\text{C}$ $V_{DS}=600V; V_{GS}=0V; T_J=150^{\circ}\text{C}$			1 70	$\mu A$
$V_{SDF}$	Diode forward voltage	$I_{SD}=3.2A, V_{GS}=0V$			1.2	V